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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	20000
Number of Logic Elements/Cells	80000
Total RAM Bits	5816320
Number of I/O	904
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1704-BCBGA, FCBGA
Supplier Device Package	1704-CFCBGA (42.5x42.5)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfscm3ga80ep1-5fc1704c

Architecture Overview

The LatticeSC architecture contains an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM Embedded Block RAM (EBR). The upper left and upper right corners of the devices contain SERDES blocks and their associated PCS blocks, as shown in Figure 2-1.

Top left and top right corner of the device contain blocks of SERDES. Each block of SERDES contains four channels (quad). Each channel contains a single serializer and de-serializer, synchronization and word alignment logic. The SERDES quad connects with the Physical Coding Sub-layer (PCS) blocks that contain logic to simultaneously perform alignment, coding, de-coding and other functions. The SERDES quad block has separate supply, ground and reference voltage pins.

The PICs contain logic to facilitate the conditioning of signals to and from the I/O before they leave or enter the FPGA fabric. The block provides DDR and shift register capabilities that act as a gearbox between high speed I/O and the FPGA fabric. The blocks also contain programmable Adaptive Input Logic that adjusts the delay applied to signals as they enter the device to optimize setup and hold times and ensure robust performance.

sysMEM EBRs are large dedicated fast memory blocks. They can be configured as RAM, ROM or FIFO. These blocks have dedicated logic to simplify the implementation of FIFOs.

The PFU, PIC and EBR blocks are arranged in a two-dimensional grid with rows and columns as shown in Figure 2-1. These blocks are connected with many vertical and horizontal routing channel resources. The place and route software tool automatically allocates these routing resources.

The corners contain the sysCLOCK Analog Phase Locked Loop (PLL) and Delay Locked Loop (DLL) Blocks. The PLLs have multiply, divide and phase shifting capability; they are used to manage the phase relationship of the clocks. The LatticeSC architecture provides eight analog PLLs per device and 12 DLLs. The DLLs provide a simple delay capability and can also be used to calibrate other delays within the device.

Every device in the family has a JTAG Port with internal Logic Analyzer (ispTRACY) capability. The sysCONFIG™ port which allows for serial or parallel device configuration. The system bus simplifies the connections of the external microprocessor to the device for tasks such as SERDES and PCS configuration or interface to the general FPGA logic. The LatticeSC devices use 1.2V as their core voltage operation with 1.0V operation also possible.

Figure 2-3. Slice Diagram

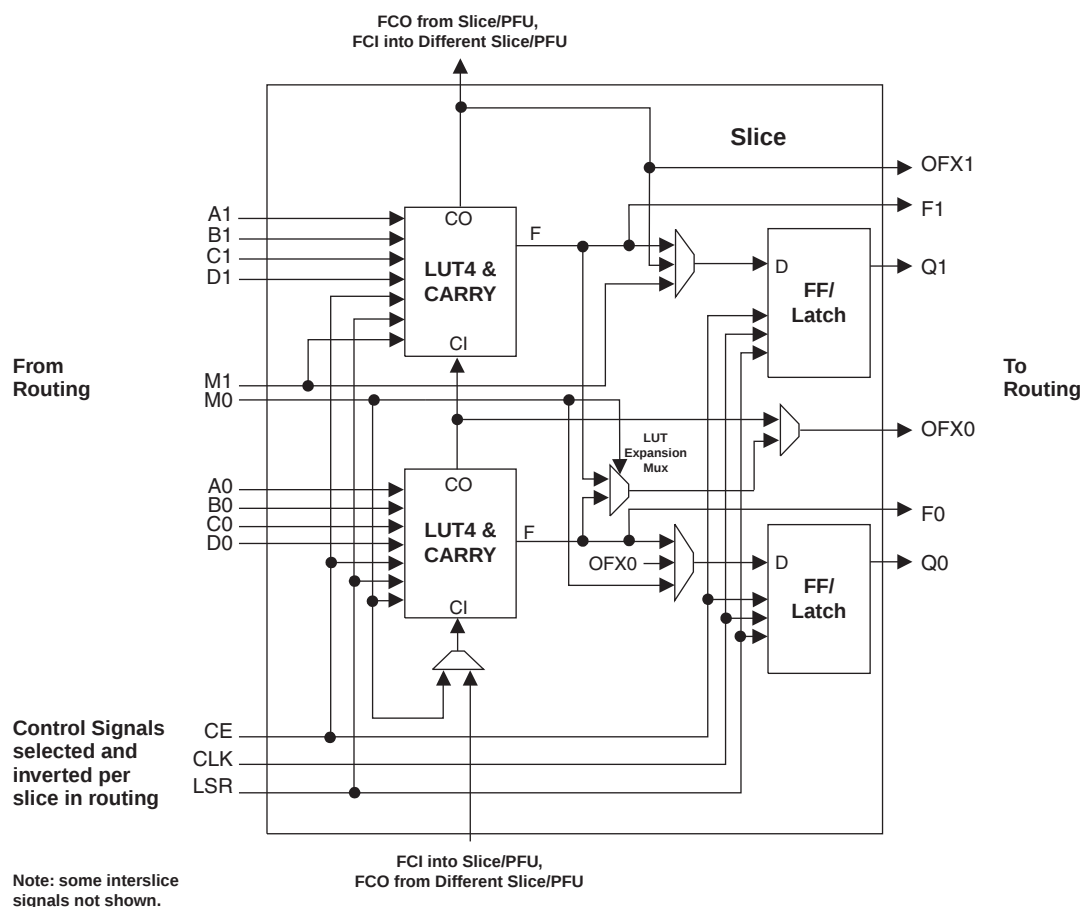
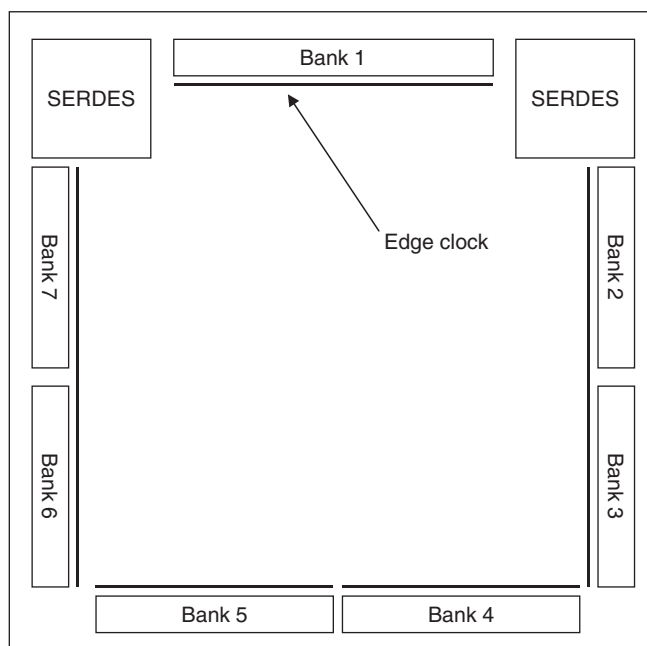


Table 2-1. Slice Signal Descriptions

Function	Type	Signal Names	Description
Input	Data signal	A0, B0, C0, D0	Inputs to LUT4
Input	Data signal	A1, B1, C1, D1	Inputs to LUT4
Input	Multi-purpose	M0	Multipurpose Input
Input	Multi-purpose	M1	Multipurpose Input
Input	Control signal	CE	Clock Enable
Input	Control signal	LSR	Local Set/Reset
Input	Control signal	CLK	System Clock
Input	Inter-PFU signal	FCI	Fast Carry In ¹
Output	Data signals	F0, F1	LUT4 output register bypass signals
Output	Data signals	Q0, Q1	Register Outputs
Output	Data signals	OFX0	Output of a LUT5 MUX
Output	Data signals	OFX1	Output of a LUT6, LUT7, LUT8 ² MUX depending on the slice
Output	Inter-PFU signal	FCO	For the right most PFU the fast carry chain output ²

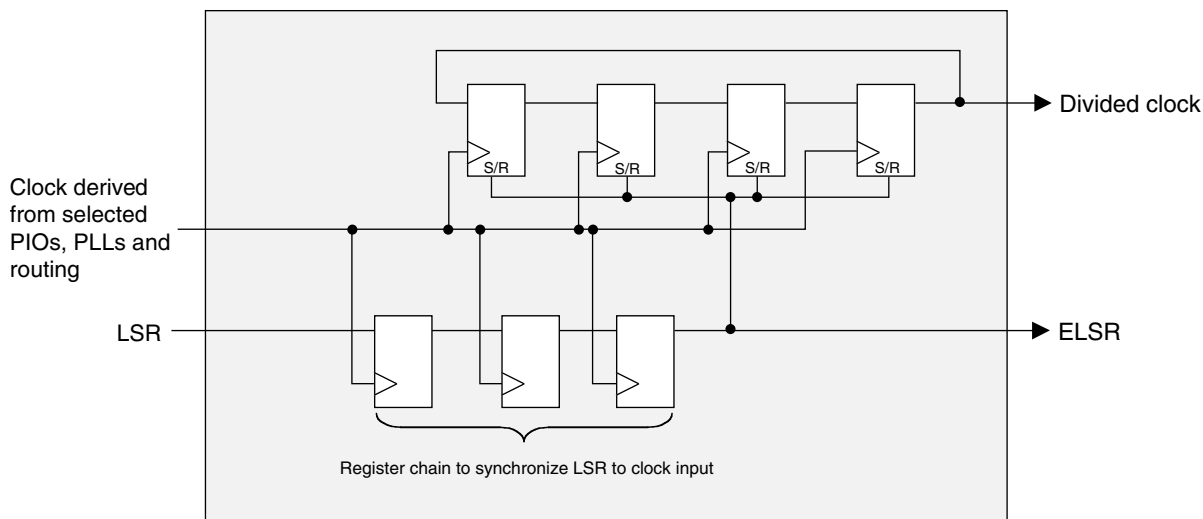
1. See Figure 2-2 for connection details.

2. Requires two PFUs.

Figure 2-7. Edge Clock Resources

Precision Clock Divider

Each set of edge clocks has four high-speed dividers associated with it. These are intended for generating a slower speed system clock from the high-speed edge clock. The block operates in a DIV2 or DIV4 mode and maintains a known phase relationship between the divided down clock and high-speed clock based on the release of its reset signal. The clock dividers can be fed from selected PIOs, PLLs and routing. The clock divider outputs serve as primary clock sources. This circuit also generates an edge local set/reset (ELSR) signal which is fed to the PIOs via the edge clock network and is used for the rest of the I/O gearing logic.

Figure 2-8. Clock Divider Circuit

Dynamic Clock Select (DCS)

The DCS is a global clock buffer with smart multiplexer functions. It takes two independent input clock sources and outputs a clock signal without any glitches or runt pulses. This is achieved irrespective of where the select signal is

- 8-bit SERDES Only
- 10-bit SERDES Only
- SONET (STS-12/STS-48)
- Gigabit Ethernet
- Fibre Channel
- XAUI
- Serial RapidIO
- PCI-Express
- Generic 8b10b

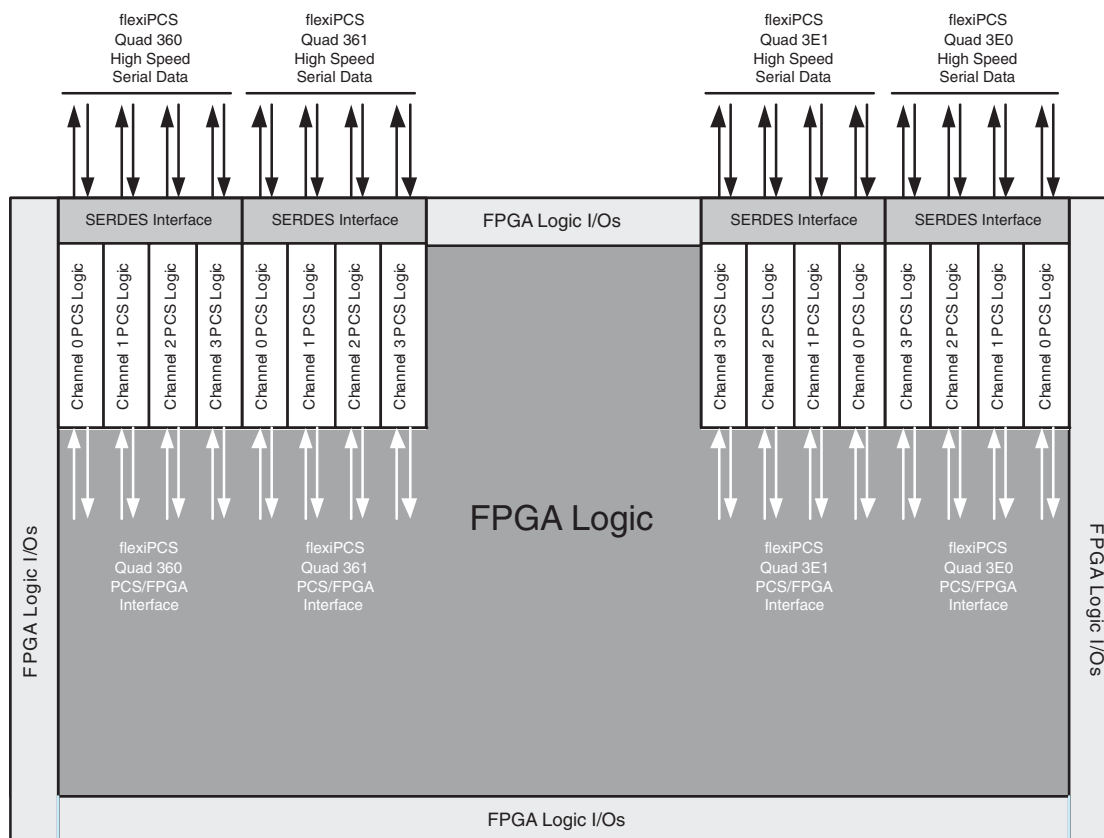
flexiPCS Quad

The flexiPCS logic is arranged in quads containing logic for four independent full-duplex data channels. Each device in the LatticeSC family has up to eight quads of flexiPCS logic. The LatticeSC Family Selection Guide table on the first page of this data sheet contains the number of flexiPCS channels present on the chip. Note that in some packages (particularly lower pin count packages), not all channels from all quads on a given device may be bonded to package pins.

Each quad supports up to four channels of full-duplex data and can be programmed into any one of several protocol based modes. Each quad requires its own reference clock which can be sourced externally or from the FPGA logic. The user can utilize between one and four channels in a quad, depending on the application.

Figure 2-30 shows an example of four flexiPCS quads in a LatticeSC device. Quads are labeled according to the address of their software controlled registers.

Figure 2-30. LatticeSC flexiPCS



Since each quad has its own reference clock, different quads can support different standards on the same chip. This feature makes the LatticeSC family of devices ideal for bridging between different standards.

Internal Logic Analyzer Capability (ispTRACY)

All LatticeSC devices support an internal logic analyzer diagnostic feature. The diagnostic features provide capabilities similar to an external logic analyzer, such as programmable event and trigger condition and deep trace memory. This feature is enabled by Lattice's ispTRACY. The ispTRACY utility is added into the user design at compile time. For additional detail refer to technical information at the end of the data sheet.

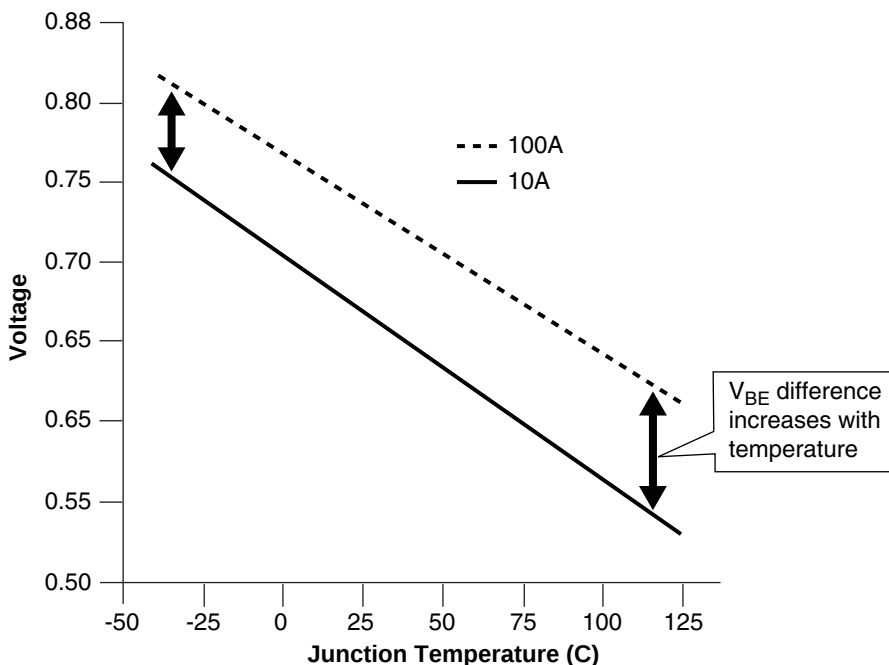
Temperature Sensing

Lattice provides a way to monitor the die temperature by using a temperature-sensing diode that is designed into every LatticeSC device. The difference in V_{BE} of the diode at two different forward currents varies with temperature. This relationship is shown in Figure 2-33. The accuracy of the temperature-sensing diode is typically $\pm 10^{\circ}\text{C}$.

On packages that include PROBE_GND, the most accurate measurements will occur between the TEMP pin and the PROBE_GND pin. On packages that do not include PROBE_GND, measurements should be made between the TEMP pin and board ground.

This temperature-sensing diode is designed to work with an external temperature sensor such as the Maxim 1617A. The Maxim 1617A is configured to measure difference in V_{BE} (of the temperature-sensing diode) at $10\mu\text{A}$ and at $100\mu\text{A}$. This difference in V_{BE} voltage varies with temperature at approximately $1.64\text{ mV}/^{\circ}\text{C}$. A typical device with a 85°C junction temperature will measure approximately 593mV . For additional detail refer to TN1115, [Temperature Sensing Diode in LatticeSC Devices](#).

Figure 2-33. Sensing Diode Typical Characteristics



Oscillator

Every LatticeSC device has an internal CMOS oscillator, which is used as a master serial clock for configuration and is also available as a potential general purpose clock (MCK) for the FPGA core. There is a K divider (divide by 2/4/8/16/32/64/128) available with this oscillator to get lower MCK frequencies. This clock is available as a general purpose clock signal to the software routing tool. For additional detail refer to technical information at the end of the data sheet.

Density Shifting

The LatticeSC family has been designed to ensure that different density devices in the same package have the same pin-out. Furthermore, the architecture ensures a high success rate when performing design migration from lower density parts to higher density parts. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likely success in each case.

PURESPEED I/O Recommended Operating Conditions

Standard	V _{CCIO} (V)			V _{REF} (V)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
LVC MOS 33	3.135	3.3	3.465	—	—	—
LVC MOS 25	2.375	2.5	2.625	—	—	—
LVC MOS 18	1.71	1.8	1.89	—	—	—
LVC MOS 15	1.425	1.5	1.575	—	—	—
LVC MOS 12	1.14	1.2	1.26	—	—	—
LV TTL	3.135	3.3	3.465	—	—	—
PCI33	3.135	3.3	3.465	—	—	—
PCIX33	3.135	3.3	3.465	—	—	—
PCIX15	1.425	1.5	1.575	0.49V _{CCIO}	0.5V _{CCIO}	0.51V _{CCIO}
AGP1X33	3.135	3.3	3.465	—	—	—
AGP2X33	3.135	3.3	3.465	0.39V _{CCIO}	0.4V _{CCIO}	0.41V _{CCIO}
SSTL18_I, II ³	1.71	1.8	1.89	0.833	0.9	0.969
SSTL25_I, II ³	2.375	2.5	2.625	1.15	1.25	1.35
SSTL33_I, II ³	3.135	3.3	3.465	1.3	1.5	1.7
HSTL15_I, II ³	1.425	1.5	1.575	0.68	0.75	0.9
HSTL15_III ^{1,3} and IV ^{1,3}	1.425	1.5	1.575	0.68	0.9	0.9
HSTL 18_I ³ , II ³	1.71	1.8	1.89	0.816	0.9	1.08
HSTL 18_III ^{1,3} , IV ^{1,3}	1.71	1.8	1.89	0.816	1.08	1.08
GTL12 ^{1,3} , GTLPLUS15 ^{1,3}	—	—	—	0.882	1.0	1.122
LVDS	—	—	—	—	—	—
Mini-LVDS	—	—	—	—	—	—
RSDS	—	—	—	—	—	—
LVPECL33 (outputs) ²	3.135	3.3	3.465	—	—	—
LVPECL33 (inputs) ^{2,4}	—	≤ 2.5	—	—	—	—
BLVDS25 ^{2,3}	2.375	2.5	2.625	—	—	—
MLVDS25 ^{2,3}	2.375	2.5	2.625	—	—	—
SSTL18D_I ³ , II ³	1.71	1.8	1.89	—	—	—
SSTL25D_I ³ , II ³	2.375	2.5	2.625	—	—	—
SSTL33D_I ³ , II ³	3.135	3.3	3.465	—	—	—
HSTL15D_I ³ , II ³	1.425	1.5	1.575	—	—	—
HSTL18D_I ³ , II ³	1.71	1.8	1.89	—	—	—

1. Input only.

2. Inputs on chip. Outputs are implemented with the addition of external resistors.

3. Input for this standard does not depend on the value of V_{CCIO}.

4. Inputs for this standard cannot be in 3.3V VCCIO banks (≤ 2.5V only).

LatticeSC/M Internal Timing Parameters¹ (Continued)

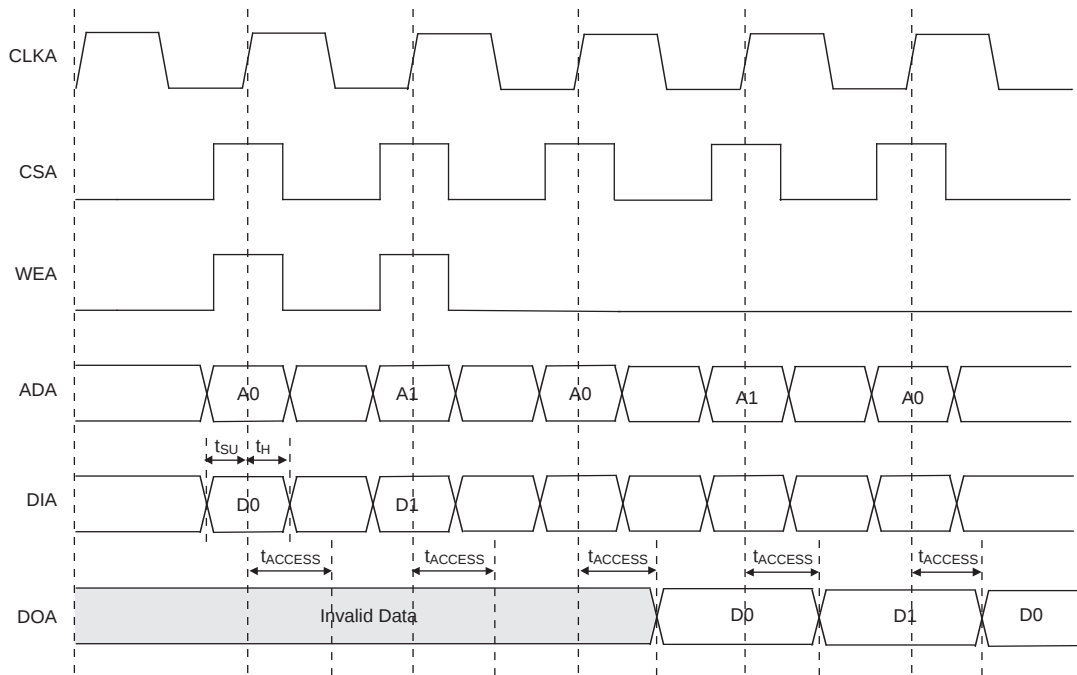
Over Recommended Commercial Operating Conditions at VCC = 1.2V +/- 5%

Parameter	Symbol	Description	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
EBR Timing									
t _{CO_EBR}	CK_Q_DEL	Clock (Read) to output from Address or Data	—	1.900	—	2.116	—	2.335	ns
t _{COO_EBR}	CK_Q_DEL	Clock (Write) to output from EBR output Register	0.390	—	0.444	—	0.498	—	ns
t _{SUDATA_EBR}	D_CK_SET	Setup Data to EBR Memory (Write clk)	-0.173	—	-0.192	—	-0.210	—	ns
t _{HDATA_EBR}	D_CK_HLD	Hold Data to EBR Memory (Write clk)	0.276	—	0.305	—	0.335	—	ns
t _{SUADDR_EBR}	A_CK_SET	Setup Address to EBR Memory (Write clk)	-0.165	—	-0.182	—	-0.200	—	ns
t _{HADDR_EBR}	A_CK_HLD	Hold Address to EBR Memory (Write clk)	0.269	—	0.298	—	0.327	—	ns
t _{SUWREN_EBR}	CE_CK_SET	Setup Write/Read Enable to EBR Memory (Write/Read clk)	0.225	—	0.226	—	0.226	—	ns
t _{HWREN_EBR}	CE_CK_HLD	Hold Write/Read Enable to EBR Memory (write/read clk)	0.073	—	0.095	—	0.116	—	ns
t _{SUCE_EBR}	CS_CK_SET	Clock Enable Setup Time to EBR Output Register (Read clk)	0.261	—	0.269	—	0.276	—	ns
t _{HCE_EBR}	CS_CK_HLD	Clock Enable Hold Time to EBR Out-put Register (Read clk)	0.023	—	0.039	—	0.055	—	ns
t _{RSTO_EBR}	RESET_Q_DEL	Reset To Output Delay Time from EBR Output Register (asynchronous)	—	0.589	—	0.673	—	0.757	ns
Cycle Boosting Timing									
t _{DEL1}	DEL1	Cycle boosting delay 1 applies to PIO, PFU, EBR	—	0.480	—	0.524	—	0.570	ns
t _{DEL2}	DEL2	Cycle boosting delay 2 applies to PIO, PFU, EBR	—	0.922	—	1.005	—	1.090	ns
t _{DEL3}	DEL3	Cycle boosting delay 3 applies to PIO, PFU, EBR	—	1.366	—	1.488	—	1.612	ns

1. Complete timing parameters for a user design will be incorporated when running ispLEVER. This is a sampling of the key timing parameters.

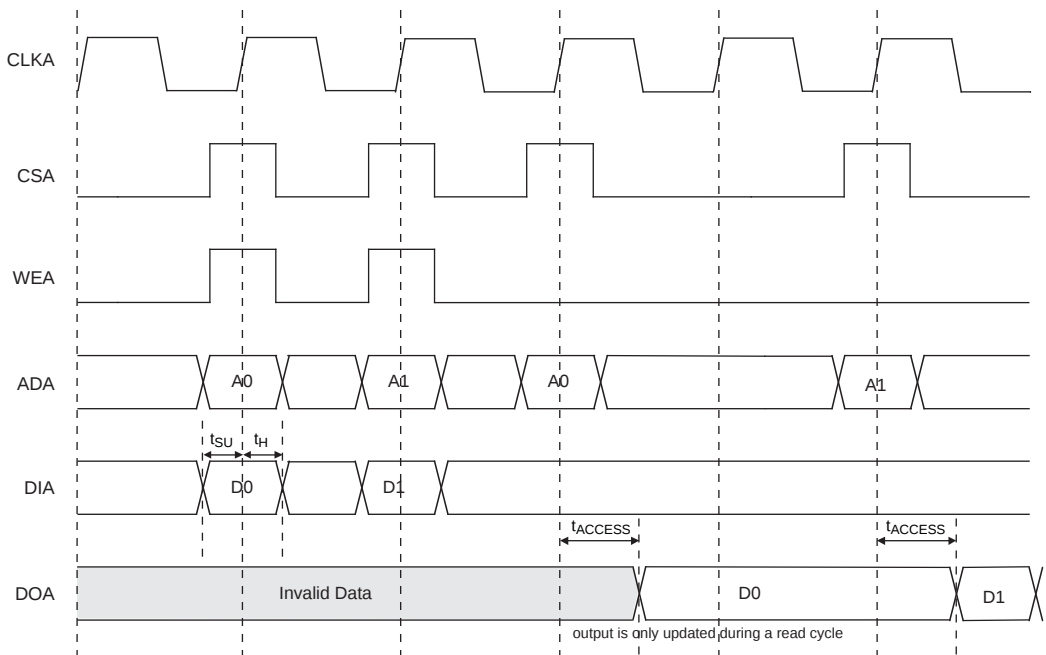
EBR Memory Timing Diagrams

Figure 3-6. Read Mode



Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive of the clock.

Figure 3-7. Read Mode with Input Registers Only



Pin Information Summary

Pin Type		256 fpBGA	900 fpBGA		1020 fcBGA	
		LFSC/M15	LFSC/M15	LFSC/M25	LFSC/M25	LFSC/M40
Single Ended User I/O		139	300	378	476	562
Differential Pair User I/O		60	141	182	235	277
LVDS Output Pairs		22	44	60	60	78
Configuration	Dedicated	9	11	11	11	11
	Muxes/MPI sysBus	0	55	55	55	72
JTAG (excluding VCCJ)		4	4	4	4	4
Dedicated Pins		2	4	4	4	4
VCC		10	46	46	40	40
VCC12		10	35	35	36	36
VCCAUX		10	36	36	32	32
VCCIO	Bank 1	3	18	18	10	10
	Bank 2	2	14	14	8	8
	Bank 3	2	15	15	10	10
	Bank 4	3	15	15	10	10
	Bank 5	3	15	15	10	10
	Bank 6	2	15	15	10	10
	Bank 7	2	16	16	8	8
VTT	Bank 2	0	2	2	2	2
	Bank 3	0	3	3	3	3
	Bank 4	0	3	3	3	3
	Bank 5	0	3	3	3	3
	Bank 6	0	3	3	3	3
	Bank 7	0	2	2	2	2
GND		26	177	177	134	134
NC		0	102	24	92	6
Single Ended User / Differential I/O per Bank	Bank 1	21/8	63/30	63/30	68/32	68/32
	Bank 2	15/7	26/13	30/15	34/17	54/27
	Bank 3	19/8	43/20	62/29	84/42	94/47
	Bank 4	25/11	50/22	66/32	84/41	99/48
	Bank 5	25/11	49/23	65/32	88/44	99/49
	Bank 6	19/8	43/20	62/29	84/42	94/47
	Bank 7	15/7	26/13	30/15	34/17	54/27
LVDS Output Pairs Per Bank	Bank 2	5	7	9	9	15
	Bank 3	6	15	21	21	24
	Bank 6	6	15	21	21	24
	Bank 7	5	7	9	9	15
VCCJ		1	1	1	1	1
SERDES (signal + power supply)		28	60	60	108	108
Total		256	900	900	1020	1152

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
N3	PL27A	6		PL30A	6	
P3	PL27B	6		PL30B	6	
P4	PL27C	6	PCLKT6_3	PL30C	6	PCLKT6_3
P2	PL28A	6		PL31A	6	
R2	PL28B	6		PL31B	6	
T3	PL28C	6	PCLKT6_2	PL31C	6	PCLKT6_2
R3	PL28D	6	PCLKC6_2	PL31D	6	PCLKC6_2
P1	PL31A	6		PL34A	6	
R1	PL31B	6		PL34B	6	
R5	PL31C	6	VREF1_6	PL34C	6	VREF1_6
R4	PL31D	6		PL34D	6	
T2	PL32A	6		PL35A	6	
U2	PL32B	6		PL35B	6	
T1	PL33A	6		PL38A	6	
U1	PL33B	6		PL38B	6	
V1	PL35A	6		PL42A	6	
W1	PL35B	6		PL42B	6	
V6	PL35D	6	DIFFR_6	PL42D	6	DIFFR_6
V2	PL36A	6		PL43A	6	
W2	PL36B	6		PL43B	6	
Y1	PL37A	6		PL44A	6	
AA1	PL37B	6		PL44B	6	
AB1	PL39A	6		PL48A	6	
AC1	PL39B	6		PL48B	6	
Y5	PL40A	6		PL49A	6	
Y6	PL40B	6		PL49B	6	
AD2	PL41A	6		PL51A	6	
AE2	PL41B	6		PL51B	6	
AB5	PL41D	6	VREF2_6	PL51D	6	VREF2_6
AC3	PL43A	6		PL52A	6	
AD3	PL43B	6		PL52B	6	
AF1	PL44A	6		PL55A	6	
AG1	PL44B	6		PL55B	6	
AB6	PL44C	6	LLC_DLLT_IN_E/LLC_DLLT_FB_F	PL55C	6	LLC_DLLT_IN_E/LLC_DLLT_FB_F
AC5	PL44D	6	LLC_DLLC_IN_E/LLC_DLLC_FB_F	PL55D	6	LLC_DLLC_IN_E/LLC_DLLC_FB_F
AF2	PL45A	6	LLC_DLLT_IN_F/LLC_DLLT_FB_E	PL57A	6	LLC_DLLT_IN_F/LLC_DLLT_FB_E
AG2	PL45B	6	LLC_DLLC_IN_F/LLC_DLLC_FB_E	PL57B	6	LLC_DLLC_IN_F/LLC_DLLC_FB_E
AC6	PL45C	6	LLC_PLLT_IN_B/LLC_PLLT_FB_A	PL57C	6	LLC_PLLT_IN_B/LLC_PLLT_FB_A
AC7	PL45D	6	LLC_PLLC_IN_B/LLC_PLLC_FB_A	PL57D	6	LLC_PLLC_IN_B/LLC_PLLC_FB_A
AE4	XRES	-		XRES	-	
AG4	VCC12	-		VCC12	-	
AD5	TEMP	6		TEMP	6	
AF5	VCC12	-		VCC12	-	
AH1	PB3A	5	LLC_PLLT_IN_A/LLC_PLLT_FB_B	PB3A	5	LLC_PLLT_IN_A/LLC_PLLT_FB_B
AJ1	PB3B	5	LLC_PLLC_IN_A/LLC_PLLC_FB_B	PB3B	5	LLC_PLLC_IN_A/LLC_PLLC_FB_B

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AF4	PB3C	5	LLC_DLLT_IN_C/LLC_DLLT_FB_D	PB3C	5	LLC_DLLT_IN_C/LLC_DLLT_FB_D
AE5	PB3D	5	LLC_DLLC_IN_C/LLC_DLLC_FB_D	PB3D	5	LLC_DLLC_IN_C/LLC_DLLC_FB_D
AG3	PB4A	5	LLC_DLLT_IN_D/LLC_DLLT_FB_C	PB4A	5	LLC_DLLT_IN_D/LLC_DLLT_FB_C
AH2	PB4B	5	LLC_DLLC_IN_D/LLC_DLLC_FB_C	PB4B	5	LLC_DLLC_IN_D/LLC_DLLC_FB_C
AD6	PB4C	5		PB4C	5	
AJ2	PB5A	5		PB5A	5	
AK2	PB5B	5		PB5B	5	
AD7	PB5C	5		PB5C	5	
AD8	PB5D	5	VREF1_5	PB5D	5	VREF1_5
AH3	PB7A	5		PB11A	5	
AJ3	PB7B	5		PB11B	5	
AF9	PB7C	5		PB11C	5	
AE10	PB7D	5		PB11D	5	
AK3	PB8A	5		PB12A	5	
AJ4	PB8B	5		PB12B	5	
AE11	PB9A	5		PB13A	5	
AF10	PB9B	5		PB13B	5	
AK4	PB11A	5		PB16A	5	
AK5	PB11B	5		PB16B	5	
AH10	PB12A	5	PCLKT5_3	PB20A	5	PCLKT5_3
AH11	PB12B	5	PCLKC5_3	PB20B	5	PCLKC5_3
AF13	PB12C	5	PCLKT5_4	PB20C	5	PCLKT5_4
AE14	PB12D	5	PCLKC5_4	PB20D	5	PCLKC5_4
AK6	PB13A	5	PCLKT5_5	PB21A	5	PCLKT5_5
AK7	PB13B	5	PCLKC5_5	PB21B	5	PCLKC5_5
AF14	PB13C	5		PB21C	5	
AJ11	PB15A	5	PCLKT5_0	PB23A	5	PCLKT5_0
AJ12	PB15B	5	PCLKC5_0	PB23B	5	PCLKC5_0
AH13	PB15D	5	VREF2_5	PB23D	5	VREF2_5
AK8	PB16A	5	PCLKT5_1	PB24A	5	PCLKT5_1
AK9	PB16B	5	PCLKC5_1	PB24B	5	PCLKC5_1
AH14	PB17A	5	PCLKT5_2	PB25A	5	PCLKT5_2
AG14	PB17B	5	PCLKC5_2	PB25B	5	PCLKC5_2
AK10	PB19A	5		PB28A	5	
AK11	PB19B	5		PB28B	5	
AH15	PB20A	5		PB29A	5	
AG15	PB20B	5		PB29B	5	
AH12	PB21A	5		PB31A	5	
AJ13	PB21B	5		PB31B	5	
AD15	PB21C	5		PB31C	5	
AE15	PB21D	5		PB31D	5	
AK12	PB23A	5		PB32A	5	
AK13	PB23B	5		PB32B	5	
AJ14	PB24A	5		PB33A	5	
AJ15	PB24B	5		PB33B	5	

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
R29	PR28B	3		PR31B	3	
P29	PR28A	3		PR31A	3	
P27	PR27C	3	PCLKT3_3	PR30C	3	PCLKT3_3
N29	PR27B	3		PR30B	3	
N28	PR27A	3		PR30A	3	
R25	PR26D	3	PCLKC3_1	PR29D	3	PCLKC3_1
R26	PR26C	3	PCLKT3_1	PR29C	3	PCLKT3_1
R28	PR26B	3	PCLKC3_0	PR29B	3	PCLKC3_0
P28	PR26A	3	PCLKT3_0	PR29A	3	PCLKT3_0
N27	PR24D	2	PCLKC2_2	PR27D	2	PCLKC2_2
P26	PR24C	2	PCLKT2_2	PR27C	2	PCLKT2_2
L30	PR24B	2	PCLKC2_0	PR27B	2	PCLKC2_0
K30	PR24A	2	PCLKT2_0	PR27A	2	PCLKT2_0
J30	PR23B	2	PCLKC2_1	PR26B	2	PCLKC2_1
H30	PR23A	2	PCLKT2_1	PR26A	2	PCLKT2_1
M26	PR22D	2	DIFFR_2	PR25D	2	DIFFR_2
M25	PR22C	2	VREF1_2	PR25C	2	VREF1_2
G29	PR22B	2		PR25B	2	
F29	PR22A	2		PR25A	2	
H28	PR19D	2		PR22D	2	
J28	PR19C	2		PR22C	2	
E30	PR19B	2		PR22B	2	
E29	PR19A	2		PR22A	2	
L26	PR18D	2	VREF2_2	PR18D	2	VREF2_2
L25	PR18C	2		PR18C	2	
F28	PR18B	2	URC_DLLC_IN_D/URC_DLLC_FB_C	PR18B	2	URC_DLLC_IN_D/URC_DLLC_FB_C
G28	PR18A	2	URC_DLLT_IN_D/URC_DLLT_FB_C	PR18A	2	URC_DLLT_IN_D/URC_DLLT_FB_C
K26	PR17D	2	URC_PLLC_IN_B/URC_PLLC_FB_A	PR17D	2	URC_PLLC_IN_B/URC_PLLC_FB_A
K25	PR17C	2	URC_PLLT_IN_B/URC_PLLT_FB_A	PR17C	2	URC_PLLT_IN_B/URC_PLLT_FB_A
D30	PR17B	2	URC_DLLC_IN_C/URC_DLLC_FB_D	PR17B	2	URC_DLLC_IN_C/URC_DLLC_FB_D
D29	PR17A	2	URC_DLLT_IN_C/URC_DLLT_FB_D	PR17A	2	URC_DLLT_IN_C/URC_DLLT_FB_D
G26	PR15D	2		PR16D	2	
H26	PR15C	2		PR16C	2	
E28	PR15B	2	URC_PLLC_IN_A/URC_PLLC_FB_B	PR16B	2	URC_PLLC_IN_A/URC_PLLC_FB_B
D28	PR15A	2	URC_PLLT_IN_A/URC_PLLT_FB_B	PR16A	2	URC_PLLT_IN_A/URC_PLLT_FB_B
J25	VCCJ	-		VCCJ	-	
H25	TDO	-	TDO	TDO	-	TDO
J26	TMS	-		TMS	-	
G25	TCK	-		TCK	-	
G24	TDI	-		TDI	-	
F26	PROGRAMN	1		PROGRAMN	1	
H24	MPIIRQN	1	CFGIRQN/MPI_IRQ_N	MPIIRQN	1	CFGIRQN/MPI_IRQ_N
F25	CCLK	1		CCLK	1	
D27	VCC12	-		VCC12	-	
E26	VCC12	-		VCC12	-	

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
E19	NC	-		NC	-	
G21	NC	-		NC	-	
G20	NC	-		NC	-	
G19	NC	-		NC	-	
F9	NC	-		NC	-	
A11	NC	-		NC	-	
G7	NC	-		NC	-	
AH9	NC	-		NC	-	
H8	VCC12	-		VCC12	-	
T8	VCC12	-		VCC12	-	
AB9	VCC12	-		VCC12	-	
AC8	VCC12	-		VCC12	-	
AB22	VCC12	-		VCC12	-	
AC23	VCC12	-		VCC12	-	
R23	VCC12	-		VCC12	-	
H23	VCC12	-		VCC12	-	
H15	VCC12	-		VCC12	-	
L24	VTT_2	2		VTT_2	2	
T23	VTT_2	2		VTT_2	2	
AC24	VTT_3	3		VTT_3	3	
T25	VTT_3	3		VTT_3	3	
W25	VTT_3	3		VTT_3	3	
AD24	VTT_4	4		VTT_4	4	
AE17	VTT_4	4		VTT_4	4	
AE18	VTT_4	4		VTT_4	4	
AC15	VTT_5	5		VTT_5	5	
AD16	VTT_5	5		VTT_5	5	
AE9	VTT_5	5		VTT_5	5	
AA6	VTT_6	6		VTT_6	6	
T7	VTT_6	6		VTT_6	6	
W6	VTT_6	6		VTT_6	6	
L7	VTT_7	7		VTT_7	7	
P7	VTT_7	7		VTT_7	7	
AA10	VCC	-		VCC	-	
AA11	VCC	-		VCC	-	
AA12	VCC	-		VCC	-	
AA13	VCC	-		VCC	-	
AA14	VCC	-		VCC	-	
AA17	VCC	-		VCC	-	
AA18	VCC	-		VCC	-	
AA19	VCC	-		VCC	-	
AA20	VCC	-		VCC	-	
AA21	VCC	-		VCC	-	
AA22	VCC	-		VCC	-	
AA9	VCC	-		VCC	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
C32	VCC12	-		VCC12	-	
E34	NC	-		PL22A	7	
F34	NC	-		PL22B	7	
F33	NC	-		PL24A	7	
G33	NC	-		PL24B	7	
K30	NC	-		PL25A	7	
L30	NC	-		PL25B	7	
G34	NC	-		PL26A	7	
H34	NC	-		PL26B	7	
M32	NC	-		PL39A	7	
N32	NC	-		PL39B	7	
P28	NC	-		PL39C	7	
R28	NC	-		PL39D	7	
J34	NC	-		PL41A	7	
K34	NC	-		PL41B	7	
P30	NC	-		PL41C	7	
R30	NC	-		PL41D	7	
W34	NC	-		PL59A	6	
Y34	NC	-		PL59B	6	
W32	NC	-		PL61A	6	
Y32	NC	-		PL61B	6	
AA34	NC	-		PL64A	6	
AB34	NC	-		PL64B	6	
AC34	NC	-		PL67A	6	
AD34	NC	-		PL67B	6	
Y30	NC	-		PL68A	6	
AA30	NC	-		PL68B	6	
AB33	NC	-		PL69A	6	
AC33	NC	-		PL69B	6	
AC2	NC	-		PR69B	3	
AB2	NC	-		PR69A	3	
AA5	NC	-		PR68B	3	
Y5	NC	-		PR68A	3	
AD1	NC	-		PR67B	3	
AC1	NC	-		PR67A	3	
AB1	NC	-		PR64B	3	
AA1	NC	-		PR64A	3	
Y3	NC	-		PR61B	3	
W3	NC	-		PR61A	3	
Y1	NC	-		PR59B	3	
W1	NC	-		PR59A	3	
R5	NC	-		PR41D	2	
P5	NC	-		PR41C	2	
K1	NC	-		PR41B	2	
J1	NC	-		PR41A	2	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
J17	PT81C	1	D20/PCLKT1_2/MPI_DATA20
D16	PT81B	1	MCA_CLK_P1_OUT
E16	PT81A	1	MCA_CLK_P1_IN
H15	PT78D	1	D21/PCLKC1_1/MPI_DATA21
H16	PT78C	1	D22/PCLKT1_1/MPI_DATA22
C15	PT78B	1	MCA_CLK_P2_OUT
C16	PT78A	1	MCA_CLK_P2_IN
L17	PT75D	1	MCA_DONE_OUT
K17	PT75C	1	BUSYN/RCLK/SCK
E17	PT75B	1	DP0/MPI_PAR0
F17	PT75A	1	MPI_TA
G17	PT73D	1	D23/MPI_DATA23
H17	PT73C	1	DP2/MPI_PAR2
A17	PT73B	1	PCLKC1_0
B17	PT73A	1	PCLKT1_0/MPI_CLK
G18	PT71D	1	DP3/PCLKC1_4/MPI_PAR3
H18	PT71C	1	D24/PCLKT1_4/MPI_DATA24
E18	PT71B	1	MPI_RETRY
F18	PT71A	1	A0/MPI_ADDR14
J18	PT69D	1	A1/MPI_ADDR15
J19	PT69C	1	A2/MPI_ADDR16
C20	PT69B	1	A3/MPI_ADDR17
C19	PT69A	1	A4/MPI_ADDR18
K18	PT66D	1	D25/PCLKC1_5/MPI_DATA25
L18	PT66C	1	D26/PCLKT1_5/MPI_DATA26
D19	PT66B	1	A5/MPI_ADDR19
E19	PT66A	1	A6/MPI_ADDR20
H19	PT63D	1	D27/MPI_DATA27
H20	PT63C	1	VREF1_1
A18	PT63B	1	A7/MPI_ADDR21
B18	PT63A	1	A8/MPI_ADDR22
H21	PT61D	1	D28/PCLKC1_6/MPI_DATA28
J21	PT61C	1	D29/PCLKT1_6/MPI_DATA29
A19	PT61B	1	A9/MPI_ADDR23
B19	PT61A	1	A10/MPI_ADDR24
H22	PT58D	1	D30/PCLKC1_7/MPI_DATA30
J22	PT58C	1	D31/PCLKT1_7/MPI_DATA31
F20	PT58B	1	A11/MPI_ADDR25
G20	PT58A	1	A12/MPI_ADDR26
K21	PT57D	1	D11/MPI_DATA11
K22	PT57C	1	D12/MPI_DATA12
A20	PT57B	1	A13/MPI_ADDR27
B20	PT57A	1	A14/MPI_ADDR28

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AP8	PB117D	4		PB131D	4	
AY3	PB119A	4		PB133A	4	
AW3	PB119B	4		PB133B	4	
AR6	PB119C	4		PB133C	4	
AR5	PB119D	4		PB133D	4	
AU5	PB120A	4		PB134A	4	
AV5	PB120B	4		PB134B	4	
AL12	PB120C	4		PB134C	4	
AL11	PB120D	4		PB134D	4	
AV3	PB121A	4		PB135A	4	
AV4	PB121B	4		PB135B	4	
AN9	PB121C	4		PB135C	4	
AN8	PB121D	4		PB135D	4	
AW1	PB123A	4		PB138A	4	
AY1	PB123B	4		PB138B	4	
AK14	PB123C	4	VREF1_4	PB138C	4	VREF1_4
AK13	PB123D	4		PB138D	4	
AV2	PB124A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D	PB139A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D
AW2	PB124B	4	LRC_DLLC_IN_C/LRC_DLLC_FB_D	PB139B	4	LRC_DLLC_IN_C/LRC_DLLC_FB_D
AM10	PB124C	4		PB139C	4	
AM9	PB124D	4		PB139D	4	
AV1	PB125A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B	PB141A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B
AU1	PB125B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B	PB141B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B
AL10	PB125C	4	LRC_DLLT_IN_D/LRC_DLLT_FB_C	PB141C	4	LRC_DLLT_IN_D/LRC_DLLT_FB_C
AL9	PB125D	4	LRC_DLLC_IN_D/LRC_DLLC_FB_C	PB141D	4	LRC_DLLC_IN_D/LRC_DLLC_FB_C
AT3	PROBE_VCC	-		PROBE_VCC	-	
AU2	PROBE_GND	-		PROBE_GND	-	
AP7	PR95D	3	LRC_PLLC_IN_B/LRC_PLLC_FB_A	PR117D	3	LRC_PLLC_IN_B/LRC_PLLC_FB_A
AN7	PR95C	3	LRC_PLLT_IN_B/LRC_PLLT_FB_A	PR117C	3	LRC_PLLT_IN_B/LRC_PLLT_FB_A
AR3	PR95B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E	PR117B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E
AR4	PR95A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E	PR117A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E
AP6	PR94D	3		PR116D	3	
AN6	PR94C	3		PR116C	3	
AT2	PR94B	3		PR116B	3	
AR2	PR94A	3		PR116A	3	
AM6	PR93D	3	LRC_DLLC_IN_E/LRC_DLLC_FB_F	PR115D	3	LRC_DLLC_IN_E/LRC_DLLC_FB_F
AL6	PR93C	3	LRC_DLLT_IN_E/LRC_DLLT_FB_F	PR115C	3	LRC_DLLT_IN_E/LRC_DLLT_FB_F
AP5	PR93B	3		PR115B	3	
AN5	PR93A	3		PR115A	3	
AL8	PR91D	3		PR112D	3	
AK8	PR91C	3		PR112C	3	
AP2	PR91B	3		PR112B	3	
AN2	PR91A	3		PR112A	3	
AJ12	PR90D	3		PR109D	3	
AH12	PR90C	3		PR109C	3	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AM27	GND	-		GND	-	
AM36	GND	-		GND	-	
AM7	GND	-		GND	-	
AP4	GND	-		GND	-	
AP40	GND	-		GND	-	
AR14	GND	-		GND	-	
AR20	GND	-		GND	-	
AR23	GND	-		GND	-	
AR29	GND	-		GND	-	
AR35	GND	-		GND	-	
AR8	GND	-		GND	-	
AT11	GND	-		GND	-	
AT17	GND	-		GND	-	
AT26	GND	-		GND	-	
AT32	GND	-		GND	-	
AU3	GND	-		GND	-	
AU39	GND	-		GND	-	
AW12	GND	-		GND	-	
AW18	GND	-		GND	-	
AW22	GND	-		GND	-	
AW28	GND	-		GND	-	
AW34	GND	-		GND	-	
AW6	GND	-		GND	-	
AY15	GND	-		GND	-	
AY21	GND	-		GND	-	
AY25	GND	-		GND	-	
AY31	GND	-		GND	-	
AY37	GND	-		GND	-	
AY9	GND	-		GND	-	
B1	GND	-		GND	-	
B42	GND	-		GND	-	
BA1	GND	-		GND	-	
BA42	GND	-		GND	-	
BB2	GND	-		GND	-	
BB41	GND	-		GND	-	
C10	GND	-		GND	-	
C12	GND	-		GND	-	
C13	GND	-		GND	-	
C16	GND	-		GND	-	
C18	GND	-		GND	-	
C19	GND	-		GND	-	
C22	GND	-		GND	-	
C24	GND	-		GND	-	
C27	GND	-		GND	-	
C28	GND	-		GND	-	

Commercial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA80E-7FCN1152C ¹	-7	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSC3GA80E-6FCN1152C ¹	-6	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSC3GA80E-5FCN1152C ¹	-5	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSC3GA80E-7FFN1152C	-7	Lead-Free Organic fcBGA	1152	COM	80.1
LFSC3GA80E-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	80.1
LFSC3GA80E-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	80.1
LFSC3GA80E-7FCN1704C ¹	-7	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSC3GA80E-6FCN1704C ¹	-6	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSC3GA80E-5FCN1704C ¹	-5	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSC3GA80E-7FFN1704C	-7	Lead-Free Organic fcBGA	1704	COM	80.1
LFSC3GA80E-6FFN1704C	-6	Lead-Free Organic fcBGA	1704	COM	80.1
LFSC3GA80E-5FFN1704C	-5	Lead-Free Organic fcBGA	1704	COM	80.1

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA80EP1-7FCN1152C ¹	-7	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-6FCN1152C ¹	-6	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-5FCN1152C ¹	-5	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-7FFN1152C	-7	Lead-Free Organic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-7FCN1704C ¹	-7	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-6FCN1704C ¹	-6	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-5FCN1704C ¹	-5	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-7FFN1704C	-7	Lead-Free Organic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-6FFN1704C	-6	Lead-Free Organic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-5FFN1704C	-5	Lead-Free Organic fcBGA	1704	COM	80.1

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA115E-6FCN1152C ¹	-6	Lead-Free Ceramic fcBGA	1152	COM	115.2
LFSC3GA115E-5FCN1152C ¹	-5	Lead-Free Ceramic fcBGA	1152	COM	115.2
LFSC3GA115E-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	115.2
LFSC3GA115E-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	115.2
LFSC3GA115E-6FCN1704C ¹	-6	Lead-Free Ceramic fcBGA	1704	COM	115.2
LFSC3GA115E-5FCN1704C ¹	-5	Lead-Free Ceramic fcBGA	1704	COM	115.2
LFSC3GA115E-6FFN1704C	-6	Lead-Free Organic fcBGA	1704	COM	115.2
LFSC3GA115E-5FFN1704C	-5	Lead-Free Organic fcBGA	1704	COM	115.2

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Industrial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA115E-6FCN1152I ¹	-6	Lead-Free Ceramic fcBGA	1152	IND	115.2
LFSC3GA115E-5FCN1152I ¹	-5	Lead-Free Ceramic fcBGA	1152	IND	115.2
LFSC3GA115E-6FFN1152I	-6	Lead-Free Organic fcBGA	1152	IND	115.2
LFSC3GA115E-5FFN1152I	-5	Lead-Free Organic fcBGA	1152	IND	115.2
LFSC3GA115E-6FCN1704I ¹	-6	Lead-Free Ceramic fcBGA	1704	IND	115.2
LFSC3GA115E-5FCN1704I ¹	-5	Lead-Free Ceramic fcBGA	1704	IND	115.2
LFSC3GA115E-6FFN1704I	-6	Lead-Free Organic fcBGA	1704	IND	115.2
LFSC3GA115E-5FFN1704I	-5	Lead-Free Organic fcBGA	1704	IND	115.2

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA115EP1-6FCN1152I ¹	-6	Lead-Free Ceramic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-5FCN1152I ¹	-5	Lead-Free Ceramic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-6FFN1152I	-6	Lead-Free Organic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-5FFN1152I	-5	Lead-Free Organic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-6FCN1704I ¹	-6	Lead-Free Ceramic fcBGA	1704	IND	115.2
LFSCM3GA115EP1-5FCN1704I ¹	-5	Lead-Free Ceramic fcBGA	1704	IND	115.2
LFSCM3GA115EP1-6FFN1704I	-6	Lead-Free Organic fcBGA	1704	IND	115.2
LFSCM3GA115EP1-5FFN1704I	-5	Lead-Free Organic fcBGA	1704	IND	115.2

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).